

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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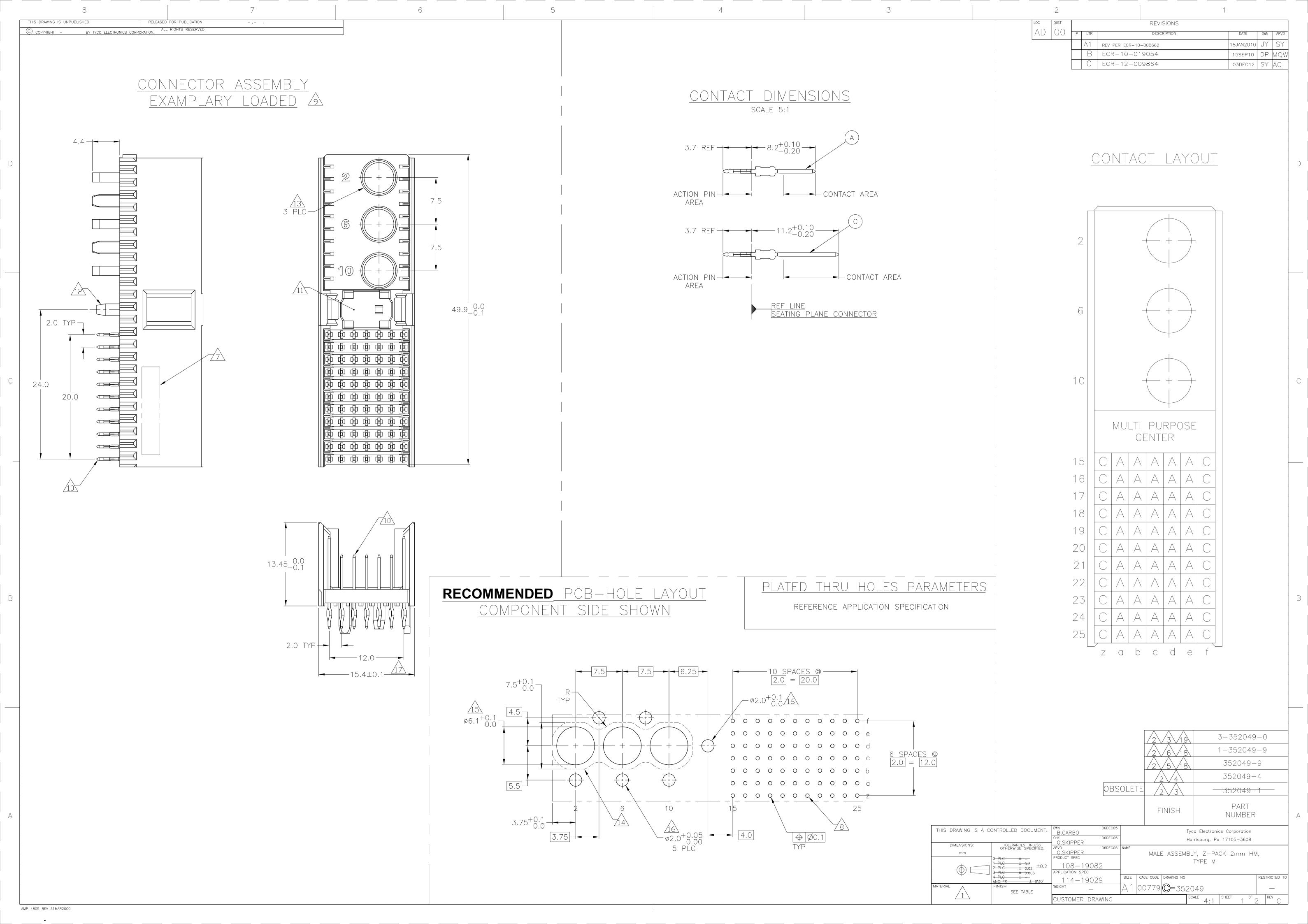
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RELEASED FOR PUBLICATION BY TYCO ELECTRONICS CORPORATION. ALL RIGHTS RESERVED. - SEE SHEET 1 1 MATERIAL: CONTACT: PHOSPHOR BRONZE. HOUSING: GLASS-FILLED POLYESTER. GENERAL PLATING SPECIFICATION: UNDERPLATING (ENTIRE CONTACT): 1.27µm MIN NICKEL AND ACTION PIN: 0.5µm MIN TIN/LEAD. FOR PLATING OF MATING SURFACES SEE APPLICABLE SPECIFICATION REFERENCE FOR EACH DASH NUMBER. CONFORMS TO ALL TESTING ACCORDING TO IEC 61076-4-101 PERFORMANCE LEVEL 2. CONFORMS TO ALL TESTING ACCORDING TO IEC 61076-4-101 PERFORMANCE LEVEL 1.  $\sqrt{5}$  connector tested and qualified against telcordia gr-1217-core quality level 3, CENTRAL OFFICE APPLICATIONS. 26 CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA GR-1217-CORE QUALITY LEVEL 3, UNCONTROLLED ENVIROMENT APPLICATIONS. 2 CONNECTOR MARKED WITH PART NUMBER AND DATE CODE. ADDITIONAL CHARACTERS OR MARKINGS, AS WELL AS THE LOCATION OF THE MARKINGS, MAY BE ADDED FOR TRACEABILITY BASED UPON MANUFACTURERS DISCRETION. PLATED-THROUGH HOLES AT 2x2mm SQUARE GRID PATTERN DEFINED BY CONTACT LAYOUT. FOR ACTUAL PIN LOADING SEE "CONTACT LAYOUT". for actual pin dimensions see "contact dimensions". AREA RESERVED FOR KEYING PART (BASIC P/N 100525). 12 POLARIZATION FEATURE. 23 CONTACT CAVITIES SUITABLE FOR Ø4.8 HIGH CURRENT, HIGH FREQUENCY OR FIBRE OPTIC CONTACTS AS PER DIN 41626 (SEE ALSO NOTE 14 AND 15). 14 PATERN FOR FIBRE OPTIC CONTACTS. NOT PLATED THROUGH HOLES, TO BE REPLACED BY  $\phi 5.9^{+0.1}_{-0.0}$  PLATED THOUGH HOLES IF STRAIGHT SOLDER CONTACTS ARE APPLIED. 16 NOT PLATED THROUGH HOLES. 17 TO BE MEASURED AT BOTTOM OF SHROUD. 28 CONNECTOR LUBRICATED WITH TELCORDIA APPROVED LUBRICANT, TECHNICAL REFERENCE: TR-NWT-001217 ISSUE 1, SEP 1992. 0.76µm MIN GOLD PLATING AT MATING SURFACES.

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THIS DRAWING IS A CONTROLLED DOCUMENT.			DWN B.CARBO	Tyco Electronics Corporation								
			CHK G.SKIPPER	06DEC05		Harrisburg, Pa 17105-3608						
	DIMENSIONS:	TOLERANCES UNLESS OTHERWISE SPECIFIED:	APVD	06DEC05	NAME							
L	0 PLC ± -		G.SKIPPER PRODUCT SPEC		1	MALE ASSEMBLY, Z-F				PACK 2mm HM,		
		1—PLC ± 0.2 2—PLC ± 0.02 3—PLC ± 0.005	108-19 APPLICATION SPEC			TYPE M						
ŀ	l	<del>4 PLC ± =</del> ANGLES ± 0'30'	114-19	029	SIZE	CAGE CODE	DRAWING NO				RESTRICTED TO	
ı	MATERIAL SEE SHEET 1	FINISH SEE SHEET 1	WEIGHT	_	A 1	00779	<b>C</b> -352	2049			_	
			CUSTOMER (	DRAWING				SCALE 4:1	SHEET	2 OF	2 REV C	

REVISIONS

DESCRIPTION

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